



5th International Workshop on Emerging Technologies for 5G Wireless Cellular Networks

In conjunction with IEEE GLOBECOM 2016, Sunday, December 4, 2016, Washington, DC, USA, <http://wcsp.eng.usf.edu/5g/2016/>

Workshop Chairs	Call for papers		
Wei Yu, University of Toronto, Canada Tommy Svensson, Chalmers U. of Technology, Sweden Lingjia Liu, University of Kansas, USA	<p>The wireless cellular network has been one of the most successful communications technologies of the last three decades. The advent of smartphones and tablets over the past several years has resulted in an explosive growth of data traffic over the cellular network not seen in previous generations. With the proliferation of more smart terminals communicating with servers and each other via broadband wireless networks, numerous new applications have also emerged to take advantage of wireless connectivity. As the fourth generation (4G) networks, namely 3GPP LTE-A, mature and become great commercial success, the research community is now increasingly looking beyond 4G and into future 5G technologies both in standardization body such as 3GPP, and in research programs such as 5GPPP in EU Horizon2020.</p> <p>Fundamental requirements that have emerged for radio access networks in the 2020 and beyond era include: 1) Capabilities for supporting massive capacity and massive connectivity; 2) Support for an increasingly diverse set of services, application and users – all with extremely diverging requirements for work and life; 3) Flexible and efficient use of all available non-contiguous spectrum for wildly different network deployment scenarios. These requirements bring a number of challenges to the design of future wireless networks, including the capability of supporting diverse traffic characteristics, massive connectivity due to massive number of devices (including machine-type terminals), and the densification and heterogeneity of such networks.</p> <p>This workshop will be a venue to brainstorm on and to identify the emerging concepts, technologies, and analytical tools for 5G cellular networks. We aim to bring together leading researchers in both academia and industry, and to provide a forum for researchers from diverse backgrounds to share their views on what 5G should be and to have an open dialogue on the future of wireless research. The goal is to identify key 5G technology drivers that can deliver significant capacity, coverage and user-experience benefits. Topics of interest include, but are not limited to the following:</p> <ul style="list-style-type: none"> • Novel radio access network (RAN) architectures <ul style="list-style-type: none"> ○ HetNets with overlay of high- and low-power nodes ○ CoMP (coordinated multi-point) transmission and reception ○ Distributed antenna systems ○ Advanced relaying, user terminal relaying ○ Small cell deployment, femtocells, picocells ○ Terminal intelligence, Context awareness • Advanced radio resource management (RRM) techniques <ul style="list-style-type: none"> ○ Interference management, interference awareness ○ Inter-cell interference coordination (ICIC, eICIC) ○ Artificial intelligence in wireless communications ○ Congestion management • Emerging technologies in physical layer <ul style="list-style-type: none"> ○ Interference-robust air interface ○ Higher-order massive MIMO, Active antenna systems (AAS) ○ Multiuser communications, Network information theory ○ Novel modulation and coding schemes, Waveforms beyond OFDM(A) • Novel services <ul style="list-style-type: none"> ○ Enhanced voice and video, Telepresence ○ Machine-to-machine (M2M), machine-type communications (MTC) ○ Point-to-point (P2P) / device-to-device (D2D) communications • mmWave communications <ul style="list-style-type: none"> ○ Channel characteristics and modeling, Feasibility studies ○ Initial access; Beamforming, beam tracking; Mobility solutions; ○ System design aspects • Energy efficiency <ul style="list-style-type: none"> ○ Energy consumption models ○ Joint RF-baseband optimization; End-to-end energy optimization • Spectrum <ul style="list-style-type: none"> ○ Aggregation of intra and inter-band carriers for both FDD and TDD ○ Cognitive radio and dynamic spectrum access, ○ Adaptive radio access techniques • Prototype and test-bed for emerging 5G technologies 		
Technical Program Chairs			
Halim Yanikomeroglu, Carleton University, Canada Charlie (Jianzhong) Zhang, Samsung Electronics, USA Peiyong Zhu, Huawei Technologies, Canada			
Keynote Speakers			
TBA			
Panel Program			
TBA			
Technical Program Committee			
<table style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 50%; vertical-align: top;"> Abdulkareem Adinoyi, Carleton University Raviraj Adve, University of Toronto İbrahim Altunbaş, Istanbul Technical University Sergey Andreev, Tampere University of Technology Imran Ansari, Texas A&M University at Qatar (TAMUQ) Jonathan Ashdown, U.S. Air Force Research Lab. (AFRL) Erdem Bala, InterDigital Anantharaman Balasubramanian, Interdigital Communications Hadi Baligh, Huawei Technologies Canada co. Ltd. Federico Boccardi, Ofcom Shengrong Bu, University of Glasgow Daniel Calabuig, Universidad Politecnica de Valencia Houda Chafnaji, INPT Rabat Rong-Rong Chen, University of Utah Runhua Chen, China Academy of Telecomm. Technology Julian Cheng, University of British Columbia Hayssam Dahrouj, Effat University Oussama Damen, University of Waterloo Zhiguo Ding, Lancaster University Qinghe Du, Xi'an Jiaotong University Lutfiye Durak-Ata, Yildiz Technical University Salman Durrani, The Australian National University Ozgur Ertug, Gazi University Carlo Fischione, KTH Ramy Gohary, Carleton University David González G, Aalto University Ekram Hossain, University of Manitoba Kianoush Hosseini, Qualcomm Inc. Salama Ikki, Lakehead University Hazer Inaltekin, Antalya International University Omneya Issa, Communications Research Centre Canada Gunes Karabulut Kurt, Istanbul Technical University </td> <td style="width: 50%; vertical-align: top;"> Mehmet Kemal Karakayali, Bell Labs, Alcatel-Lucent Witold Krzymień, University of Alberta / TRILabs Michel Kulhandjian, State University of New York at Buffalo Yicheng Lin, University of Toronto Liang Liu, University of Toronto Liangping Ma, Interdigital Behrooz Makki, Chalmers University of Technology Nicholas Mastronarde, University at Buffalo Hani Mehrpouyan, Boise State University Keivan Navaie, Lancaster University Apostolos Papatthassiou, Intel Corporation Nikolaos Pappas, Linköping University Benoit Pelletier, InterDigital Canada Yinan Qi, Samsung R & D Institute UK Sandra Roger, Universitat Politècnica de València Hamid Saedi, Tarbiat Modares University Karim Seddik, American University in Cairo Nima Seifi, Ericsson Research Cong Shen, University of Science and Technology of China Gokul Sridharan, Rutgers University Leszek Szczecinski, INRS-EMT Chintha Tellambura, University of Alberta Milos Tesanovic, Samsung Electronics R&D Institute UK Antti Tölli, University of Oulu Stefan Valentin, Huawei Technologies Xianbin Wang, University of Western Ontario Joerg Widmer, IMDEA Networks Institute Jingxian Wu, University of Arkansas Xiaodong Xu, Beijing Univ. of Posts and Telecommunications Yang Yi, University of Kansas Di Yuan, Linköping University Wolfgang Zirwas, Nokia Siemens Networks GmbH&CoKG Yaning Zou, Technische Universität Dresden </td> </tr> </table>		Abdulkareem Adinoyi, Carleton University Raviraj Adve, University of Toronto İbrahim Altunbaş, Istanbul Technical University Sergey Andreev, Tampere University of Technology Imran Ansari, Texas A&M University at Qatar (TAMUQ) Jonathan Ashdown, U.S. Air Force Research Lab. 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Important Dates			
Full Paper Submission: 1 July 2016, 11:59 pm (NYT) Acceptance Notification: 1 September 2016, 11:59 pm (NYT) Camera-Ready Submission: 1 October 2016, 11:59 pm (NYT) Workshop: 4 December 2016 Submit papers using EDAS: https://edas.info/N22545 Authors should follow Globecom submission guidelines (maximum 6 pages).			